













- ► PCB / CHIP LED
- ▶ 1209 (3224) 2.5t
- ► Green (525nm)

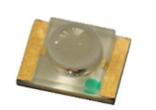
N0G10S57RV











1209 2.5t Series

## **APPLICATIONS:**

- Indication Light
- Switch Light
- 3C Application

**FEATURES:** 

- Package: PCB / CHIP LED Top View Package
- Forward Current: 20mA Forward Voltage (typ.): 3.2V
- Luminous Intensity (typ.): 8800mcd@20mA
- Colour: Green
- Wavelength: 525nm Viewing angle: 15°
- **Materials:** 
  - Die: InGaN
  - Resin: Epoxy (Water Clear)
- Operating Temperature: -40~+80°C
- Storage Temperature: -40~+85°C
- **Grouping parameters:** 
  - Forward voltage
  - Luminous intensity
  - Dominant wavelength
- Soldering methods: Reflow
- Preconditioning: acc. to JEDEC Level 3
- Packing: 8mm tape with 1500/reel, ø180mm (7")



## **CHARACTERISTICS:**

# Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I <sub>F</sub>	30	mA
Peak Forward Current Duty 1/8@1KHz	I <sub>FP</sub>	125	mA
Reverse Current @5V	I <sub>R</sub>	10	μΑ
Power Dissipation	PD	111	mW
Operating Temperature	T <sub>OPR</sub>	-40~+80	°C
Storage Temperature	T <sub>STG</sub>	-40~+85	°C

# Electrical & Optical Characteristics (Ta=25°C)

Darameter	Symbol	Values			Unit	Test
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	$V_{F}$	2.8	3.2	3.7	V	I <sub>F</sub> =20mA
Luminous Intensity	I <sub>V</sub>	5200	8800	14200	mcd	I <sub>F</sub> =20mA
Dominant Wavelength	$\lambda_{\scriptscriptstyle D}$	520	525	530	nm	I <sub>F</sub> =20mA
Peak Wavelength	$\lambda_{ extsf{P}}$		520		nm	I <sub>F</sub> =20mA
Spectral Line Half Bandwidth	Δλ		35		nm	I <sub>F</sub> =20mA
Viewing Angle	2θ <sub>1/2</sub>		15		deg	I <sub>F</sub> =20mA

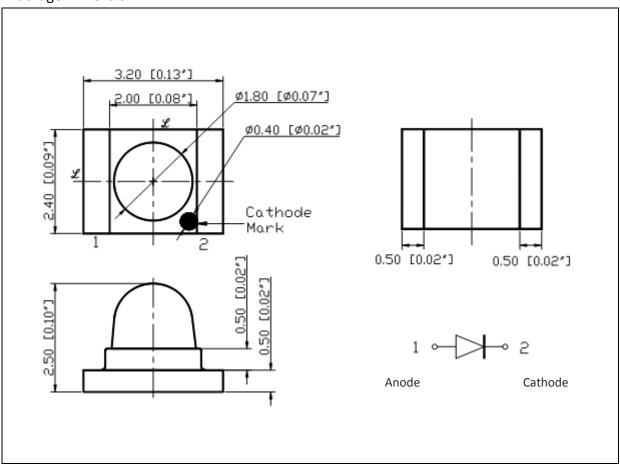
<sup>1.</sup> Luminous intensity (I<sub>V</sub>) ±15%, Forward Voltage (V<sub>F</sub>) ±0.1V, Viewing angle(2 $\theta_{1/2}$ ) ±5%

<sup>2.</sup> IS standard testing



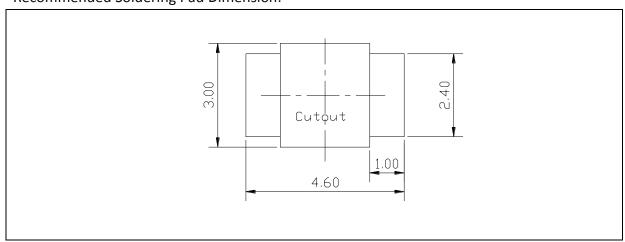
## **OUTLINE DIMENSION:**

## Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

# Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



# **BINNING GROUPS:**

# Forward Voltage Classifications (I<sub>F</sub> = 20mA):

Code	Min.	Max.	Unit
F	2.8	3.1	
G	3.1	3.4	V
Н	3.4	3.7	

# Luminous Intensity Classifications (I<sub>F</sub> = 20mA):

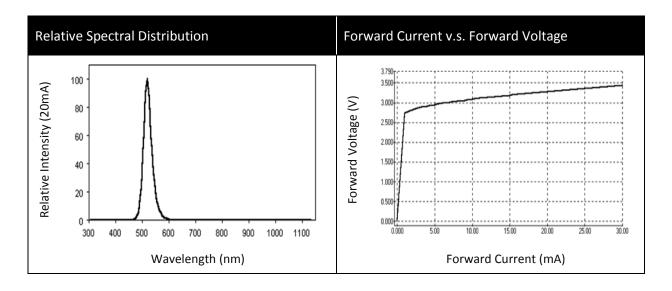
Code	Min.	Max.	Unit
А	5200	6800	
В	6800	8800	mad
С	8800	11200	mcd
D	11200	14200	

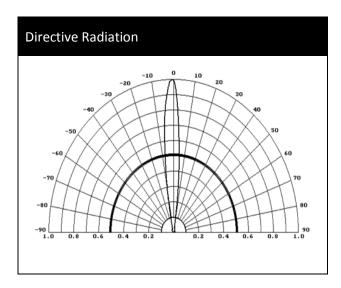
# Dominant Wavelength Classifications ( $I_F = 20$ mA):

Code	Min.	Max.	Unit
U	520	522.5	
V	522.5	525	
W	525	527.5	nm
X	527.5	530	



# **ELECTRO-OPTICAL CHARACTERISTICS:**

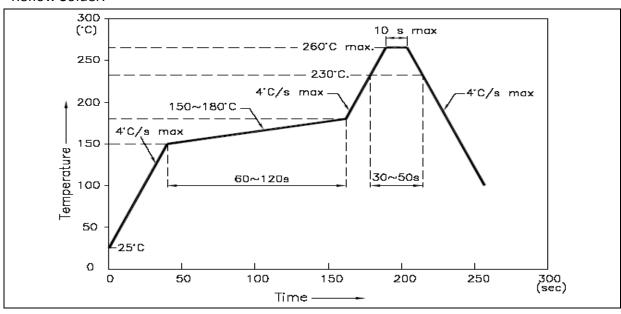






# **RECOMMENDED SOLDERING PROFILE:**

## Reflow Solder:



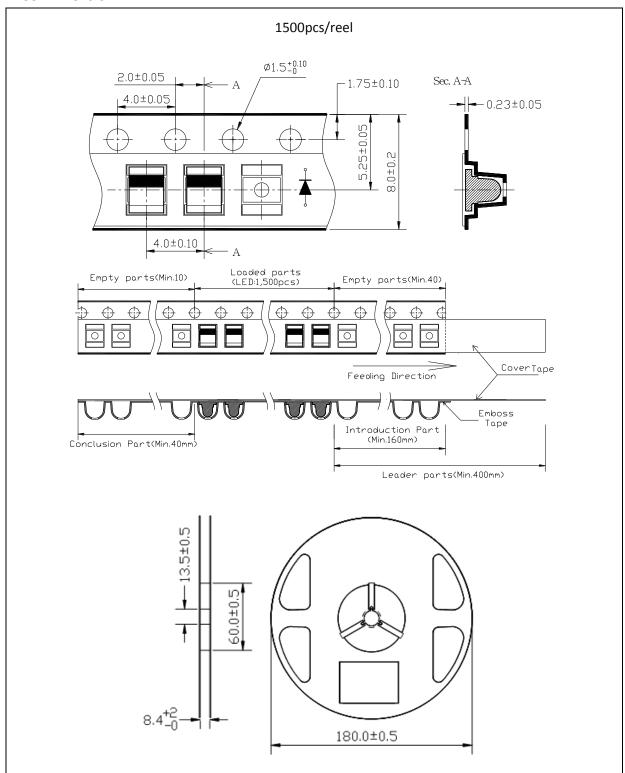
#### Note:

- 1. Recommend reflow temperature 245°C.
- 2. Maximum reflow soldering: 2 times.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



## **PACKING SPECIFICATION:**

## Reel Dimension:





#### **PRECAUTIONS OF USE:**

#### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

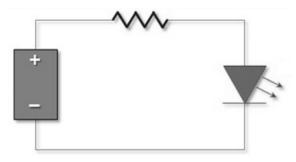
## Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 70±3°C x 24hrs and <5%RH, taped / reel package.</li>
- 100±3°C x 2hrs, bulk (loose) package.
- 130±3°C x 30min, bulk (loose) package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

## **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

## Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

## ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



# **REVISION RECORD:**

Version	Date	Summary of Revision
A1.0	11/08/2015	Datasheet set-up.